3.3V Surface Mount 7.5x5mm **Crystal Clock Oscillator** HSM9





The Connor-Winfield HSM943, HSM933, HSM923, and HSM913 are 7.5mm x 5mm, 3.3V LVCMOS, Surface Mount, Fixed Frequency Crystal Oscillators (XO) designed for use in all applications requiring precision clocks. The RoHS compliant surface mount package is designed for high-density mounting and is optimum for mass production

Features:

1.0 to 170 MHz 3.3V Operation RoHS Compliant Tri-State Enable/Disable

Power Saving Function: 10uA When Disabled

Overall Frequency Tolerance:

HSM943 ± 20 ppm, HSM913 ± 25 ppm HSM923 ± 50 ppm, HSM933 ± 100 ppm

Temperature Range: -10 to 70°C Ceramic Surface Mount Package Tape and Reel Packaging

Absolute Maximum Ratings

Parameter	Minimum	Nominal	Maximum	Units	Notes
Storage Temperature	-55	-	125	°C	
Supply Voltage (Vcc)	-0.5	-	5.0	Vdc	
Operating Specifications					
Parameter	Minimum	Nominal	Maximum	Units	Notes
Frequency Range (Fo) HSM943 HSM913 HSM923 HSM933	1.0	-	125 & 155.52 170 170 170	MHz	
Frequency Tolerance HSM943 HSM913 HSM923 HSM933	-20 -25 -50 -100	-	20 25 50 100	ppm	1
Operating Temp Range	-10	-	70	°C	
Supply Voltage (Vdd)	2.97	3.3	3.63	Vdc	
Supply Current (Icc) - 1.000 to 31.999 MHz 32 to 49.999 MHz 50 to 66.999 MHz 67 to 124.999 MHz 125 to 170 MHz	-		mA 15 20 25 40 50		

Input Characteristics

Parameter	Minimum	Nominal	Maximum	Units	Notes
Enable Voltage - (Vih)	≥ 70% Vdd	-	-	Vdc	2
Disable Voltage - (Vil)	-	-	≤ 30% Vdd	Vdc	
Enable Time	-	-	10	mS	
Disable Time	-	-	150	nS	
Output Disable Current (Icc)	-	-	10	uA	

LVCMOS Output Characteristics

Parameter	Minimum	Nominal	Maximum	Units	Notes
Load -	-	15	рF		
Voltage High (Voh)	2.91	-	-	Vdc	
Low (Vol)	-	-	0.33		
CurrentHigh (loh)	-4	-	-	mA	
Low (IoI)	-	-	4		
Duty Cycle at 50% of Vcc	45	50	55	%	
Rise / Fall Time: 20% to 80%					
1.000 to 19.999 MHz	-	3.0	6.0	nS	
20.00 to 49.999 MHz	-	2.0	4.0		
50.00 to 99.9999 MHz	-	1.5	3.0		
100.00 to 170 MHz	-	0.5	1.0		
Start-Up Time	-	-	10	mS	
Jitter (10 Hz to 20 MHz)	-	-	5	pS RMS	
(12 kHz to 20 MHz)	-	-	1	pS RMS	



- 1. Inclusive of calibration @ 25°C, frequency vs temperature stability, supply voltage change, load change, shock and vibration, 15 years aging. 2. Oscillator output is enabled with no connection on pad 1
- 31 27 March 2012
- Sm007 Page 1 of 2 Revision Date

Bulletin

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Specifications subject to change without notice. All dimensions in inches. © Copyright 2012 The Connor-Winfield Corporation



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Package Characteristics

Package Hermetically sealed ceramic package and metal cover

Environmental Characteristics

Temperature Cycle The specimen shall meet electrical characteristics after tested 5 cycles of -55°C / 30 minutes and +125°C / 30 minutes

Hermetical No bubbles appear in Flourinert (FC-43) at 125°C ±5°C for 5 minutes

Solvent Resistance Marking will withstand immersion in

Isopropyl Alcohol or Trichloroethylene

Soldering

General Conditions 260°C max x 10 sec max x 2 times max or

230°C max x 180 sec max x 1 time

Typical Operation Data (Vapor phase reflow)

20 to 100 sec up to 215°C, 50 sec

at 215°C, then down to room temperature per 1 to 5°C / sec

Mechanical Characteristics

Free Drop The specimen shall meet electrical characteristics after tested 3 times,

Free Drop testing on the hard wooden board from a height of 75 cm.

Vibration The specimen shall meet electrical characteristics after tested

by the following conditions: 10-55Hz 1.5mm Amplitude, 55-2000 Hz 20 G's, 2 hours for each plane

Thermal Shock After applied Thermal Shock of 260°C

 $\max x$ 10 sec $\max x$ 2 times, or 230°C $\max x$ 180 sec \max ,

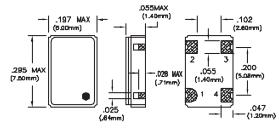
the specimen shall meet electrical characteristics

Solderability

(EIAJ-RCX-0102.101 Condition 1a)

- 1) Flux: MIL-F-14256 (WW Rosin=25%, Isopropyl Alcohol = 75%)
- 2) Solder: QQ-S-571 (Sn = 63%, Pb = 37%)
- 3) Solder bath temperature: 235°C ±5°C
- 4) Depth of immersion: Up to electrical terminal
- 5) Immersing time: Within 2 sec ±0.5 sec into solder bath

After performing the above procedures, a newly soldered coverage shall be greater than 90%

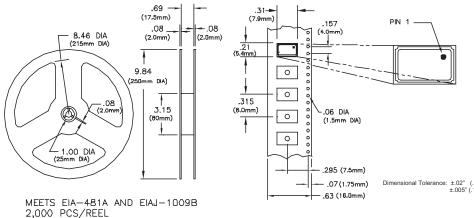


Pin Connections

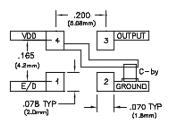
- 1: Tri-State E/D
- 2: Ground
- 3: Output
- 4: VDD

Dimensional Tolerance: ±.02" (.508mm) ±.005" (.127mm)

Tape and Reel Dimensions

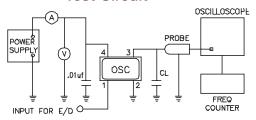


Suggested Pad Layout

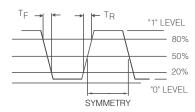


Bypass capacitor, C-by, should be ceramic capacitor \geqslant .01uf.

Test Circuit



Output Waveform



Marking Information

Part Number	Marking Variations
HSM913	SM913XX HM913XX
HSM923	HSM923XX HM923XX
HSM933	HSM933XX HM933XX
HSM943	HSM943XX HM943XX
	XX = Date Code

Ordering Information



Bulletin	Sm007
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